## 8-Channel DAS with 14-Bit, Bipolar Input, Simultaneous Sampling ADC

## Data Sheet

## FEATURES

8 simultaneously sampled inputs
True bipolar analog input ranges: $\pm 10 \mathrm{~V}, \pm 5 \mathrm{~V}$
Single 5 V analog supply and 2.3 V to $5.25 \mathrm{~V} \mathrm{~V}_{\text {dRIVE }}$
Fully integrated data acquisition solution
Analog input clamp protection
Input buffer with 1 M $\Omega$ analog input impedance
Second-order antialiasing analog filter
On-chip accurate reference and reference buffer
14-bit ADC with 200 kSPS on all channels
Flexible parallel/serial interface SPI/QSPITM/MICROWIRE ${ }^{\text {TM } / D S P ~ c o m p a t i b l e ~}$
Pin-compatible solutions from 14 bits to 18 bits
Performance
7 kV ESD rating on analog input channels
Fast throughput rate: $\mathbf{2 0 0}$ kSPS for all channels
85.5 dB SNR at 50 kSPS

INL $\pm 0.25$ LSB, DNL $\pm 0.25$ LSB
Low power: $\mathbf{1 0 0} \mathbf{~ m W}$ at 200 kSPS
Standby mode: 25 mW typical
64-lead LQFP package

## APPLICATIONS

Power-line monitoring and protection systems
Multiphase motor control
Instrumentation and control systems
Multiaxis positioning systems
Data acquisition systems (DAS)

Table 1. High Resolution, Bipolar Input, Simultaneous
Sampling DAS Solutions

| Resolution | Single-Ended <br> Inputs | Number of Simultaneous <br> Sampling Channels |
| :--- | :--- | :--- |
| 18 Bits | AD7608 | 8 |
| 16 Bits | AD7606 | 8 |
|  | AD7606-6 | 6 |
|  | AD7606-4 | 4 |
| 14 Bits | AD7607 | 8 |



Rev. B

## AD7607

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## AD7607

## GENERAL DESCRIPTION

The AD7607 ${ }^{1}$ is a 14 -bit, simultaneous sampling, analog-todigital data acquisition system (DAS). The part contains analog input clamp protection; a second-order antialiasing filter; a track-and-hold amplifier; a 14-bit charge redistribution, successive approximation analog-to-digital converter (ADC); a flexible digital filter; a 2.5 V reference and reference buffer; and high speed serial and parallel interfaces.
The AD7607 operates from a single 5 V supply and can accommodate $\pm 10 \mathrm{~V}$ and $\pm 5 \mathrm{~V}$ true bipolar input signals while sampling at throughput rates of up to 200 kSPS for all channels. The input
clamp protection circuitry can tolerate voltages of up to $\pm 16.5 \mathrm{~V}$. The AD7607 has $1 \mathrm{M} \Omega$ analog input impedance, regardless of sampling frequency. The single supply operation, on-chip filtering, and high input impedance eliminate the need for driver op amps and external bipolar supplies. The AD7607 antialiasing filter has a 3 dB cutoff frequency of 22 kHz and provides 40 dB antialias rejection when sampling at 200 kSPS . The flexible digital filter is pin driven and can be used to simplify external filtering.

## SPECIFICATIONS

$\mathrm{V}_{\text {REF }}=2.5 \mathrm{~V}$ external/internal, $\mathrm{AV}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to $5.25 \mathrm{~V}, \mathrm{~V}_{\text {DRIVE }}=2.3 \mathrm{~V}$ to 5.25 V , $\mathrm{f}_{\text {SAMPLE }}=200 \mathrm{kSPS}, \mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\text {MIN }}$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted. ${ }^{1}$
Table 2.

\begin{tabular}{|c|c|c|c|c|c|}
\hline Parameter \& Test Conditions/Comments \& Min \& Typ \& Max \& Unit \\
\hline \begin{tabular}{l}
DYNAMIC PERFORMANCE \\
Signal-to-(Noise + Distortion) (SINAD) \({ }^{2,3}\) \\
Signal-to-Noise Ratio (SNR) \({ }^{2}\) \\
Total Harmonic Distortion (THD) \({ }^{2}\) \\
Peak Harmonic or Spurious Noise (SFDR) \({ }^{2}\) \\
Intermodulation Distortion (IMD) \({ }^{2}\) \\
Second-Order Terms \\
Third-Order Terms \\
Channel-to-Channel Isolation \({ }^{2}\)
\end{tabular} \& \begin{tabular}{l}
\(\mathrm{f}_{\mathrm{N}}=1 \mathrm{kHz}\) sine wave, unless otherwise noted \\
No oversampling; \(\pm 10 \mathrm{~V}\) range \\
No oversampling; \(\pm 5 \mathrm{~V}\) range \\
Oversampling by \(4, \mathrm{f}_{\mathrm{iN}}=130 \mathrm{~Hz}\) \\
No oversampling
\[
\mathrm{fa}=1 \mathrm{kHz}, \mathrm{fb}=1.1 \mathrm{kHz}
\] \\
fin on unselected channels up to 160 kHz
\end{tabular} \& \[
\begin{aligned}
\& 84 \\
\& 83.5
\end{aligned}
\] \& \begin{tabular}{l}
84.5 \\
84.5 \\
85.5 \\
84.5 \\
-107 \\
-108 \\
-110 \\
-106 \\
-95
\end{tabular} \& -95 \& \begin{tabular}{l}
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB \\
dB
\end{tabular} \\
\hline \begin{tabular}{l}
ANALOG INPUT FILTER \\
Full Power Bandwidth \\
tgroup delay
\end{tabular} \& \[
\begin{aligned}
\& -3 \mathrm{~dB}, \pm 10 \mathrm{~V} \text { range } \\
\& -3 \mathrm{~dB}, \pm 5 \mathrm{~V} \text { range } \\
\& -0.1 \mathrm{~dB}, \pm 10 \mathrm{~V} \text { range } \\
\& -0.1 \mathrm{~dB}, \pm 5 \mathrm{~V} \text { range } \\
\& \pm 10 \mathrm{~V} \text { Range } \\
\& \pm 5 \mathrm{~V} \text { Range } \\
\& \hline
\end{aligned}
\] \& \& \[
\begin{aligned}
\& 23 \\
\& 15 \\
\& 10 \\
\& 5 \\
\& 11 \\
\& 15
\end{aligned}
\] \& \& \begin{tabular}{l}
kHz \\
kHz \\
kHz \\
kHz \\
\(\mu \mathrm{s}\) \\
\(\mu \mathrm{s}\)
\end{tabular} \\
\hline \begin{tabular}{l}
DC ACCURACY \\
Resolution \\
Differential Nonlinearity \({ }^{2}\) \\
Integral Nonlinearity \({ }^{2}\) \\
Positive/Negative Full-Scale Error \({ }^{2,5}\) \\
Positive Full-Scale Error Drift \({ }^{2}\) \\
Negative Full-Scale Error Drift \\
Positive/Negative Full-Scale Error Matching \({ }^{2}\) \\
Bipolar Zero Code Error \({ }^{2,6}\) \\
Bipolar Zero Code Error Drift \({ }^{2}\) \\
Bipolar Zero Code Error Matching \\
Total Unadjusted Error (TUE)
\end{tabular} \& \begin{tabular}{l}
No missing codes \\
External reference \\
Internal reference \\
External reference \\
Internal reference \\
External reference \\
Internal reference \\
\(\pm 10 \mathrm{~V}\) range \\
\(\pm 5 \mathrm{~V}\) range \\
\(\pm 10 \mathrm{~V}\) range \\
\(\pm 5 \mathrm{~V}\) range \\
\(\pm 10 \mathrm{~V}\) range \\
\(\pm 5 \mathrm{~V}\) range \\
\(\pm 10 \mathrm{~V}\) range \\
\(\pm 5 \mathrm{~V}\) range \\
\(\pm 10 \mathrm{~V}\) range \\
\(\pm 5 \mathrm{~V}\) range
\end{tabular} \& 14 \& \[
\begin{aligned}
\& \pm 0.25 \\
\& \pm 0.25 \\
\& \pm 2 \\
\& \pm 2 \\
\& \pm 2 \\
\& \pm 7 \\
\& \pm 4 \\
\& \pm 8 \\
\& 2 \\
\& 4 \\
\& \pm 0.5 \\
\& \pm 1 \\
\& 10 \\
\& 5 \\
\& 1 \\
\& 3 \\
\& \pm 0.5 \\
\& \pm 1 \\
\& \hline
\end{aligned}
\] \& \(\pm 0.95\)
\(\pm 0.5\)
\(\pm 9\)

8
10
$\pm 2$
$\pm 3.5$
2.5

6 \& | Bits |
| :--- |
| LSB ${ }^{4}$ |
| LSB |
| LSB |
| LSB |
| ppm $/{ }^{\circ} \mathrm{C}$ |
| ppm $/{ }^{\circ} \mathrm{C}$ |
| $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| ppm $/{ }^{\circ} \mathrm{C}$ |
| LSB |
| LSB |
| LSB |
| LSB |
| $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| $\mu \mathrm{V} /{ }^{\circ} \mathrm{C}$ |
| LSB |
| LSB |
| LSB |
| LSB | <br>

\hline ANALOG INPUT Input Voltage Ranges Input Current Input Capacitance ${ }^{7}$ Input Impedance \& | $\begin{aligned} & \text { RANGE }=1 \\ & \text { RANGE }=0 \\ & +10 \mathrm{~V} \\ & +5 \mathrm{~V} \end{aligned}$ |
| :--- |
| See the Analog Input section | \& \& \[

$$
\begin{aligned}
& 5.4 \\
& 2.5 \\
& 5 \\
& 1
\end{aligned}
$$

\] \& \[

$$
\begin{aligned}
& \pm 10 \\
& \pm 5
\end{aligned}
$$

\] \& | V |
| :--- |
| $\mu \mathrm{A}$ |
| $\mu \mathrm{A}$ |
| pF |
| $\mathrm{M} \Omega$ | <br>

\hline
\end{tabular}

| Parameter | Test Conditions/Comments | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| REFERENCE INPUT/OUTPUT <br> Reference Input Voltage Range <br> DC Leakage Current Input Capacitance ${ }^{7}$ Reference Output Voltage <br> Reference Temperature Coefficient | REF SELECT = 1 <br> REFIN/REFOUT | $2.475$ | $\begin{aligned} & 2.5 \\ & \\ & 7.5 \\ & 2.49 / \\ & 2.505 \\ & \pm 10 \end{aligned}$ | $\begin{aligned} & 2.525 \\ & \pm 1 \end{aligned}$ | V <br> $\mu \mathrm{A}$ <br> pF <br> V <br> $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| LOGIC INPUTS <br> Input High Voltage (VinH) <br> Input Low Voltage (Vinı) <br> Input Current (lin) <br> Input Capacitance $\left(\mathrm{C}_{\mathrm{IN}}\right)^{7}$ |  | $0.9 \times V_{\text {drive }}$ | 5 | $\begin{aligned} & 0.1 \times V_{\text {DRIVE }} \\ & \pm 2 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| LOGIC OUTPUTS <br> Output High Voltage ( $\mathrm{V}_{\mathrm{OH}}$ ) <br> Output Low Voltage (Vol) <br> Floating-State Leakage Current Floating-State Output Capacitance ${ }^{7}$ Output Coding | $\begin{aligned} & I_{\text {source }}=100 \mu \mathrm{~A} \\ & \mathrm{I}_{\text {SIIK }}=100 \mu \mathrm{~A} \end{aligned}$ <br> Twos complement | $V_{\text {drive }}-0.2$ | $\begin{aligned} & \pm 1 \\ & 5 \end{aligned}$ | $\begin{aligned} & 0.2 \\ & \pm 20 \end{aligned}$ | $\begin{aligned} & \mathrm{V} \\ & \mathrm{~V} \\ & \mu \mathrm{~A} \\ & \mathrm{pF} \end{aligned}$ |
| CONVERSION RATE <br> Conversion Time <br> Track-and-Hold Acquisition Time Throughput Rate | All eight channels included; see Table 3 <br> All eight channels included |  | $4$ | 200 | $\mu \mathrm{s}$ $\mu \mathrm{s}$ kSPS |
| POWER REQUIREMENTS <br> $A V_{c c}$ <br> Vdrive <br> $I_{\text {total }}$ <br> Normal Mode (Static) <br> Normal Mode (Operational) ${ }^{8}$ <br> Standby Mode <br> Shutdown Mode <br> Power Dissipation ${ }^{8}$ <br> Normal Mode (Static) <br> Normal Mode (Operational) <br> Standby Mode <br> Shutdown Mode | Digital inputs $=0 \mathrm{~V}$ or $\mathrm{V}_{\text {drive }}$ | $\begin{aligned} & 4.75 \\ & 2.3 \end{aligned}$ | $\begin{aligned} & 16 \\ & 20 \\ & 5 \\ & 2 \\ & 80 \\ & 100 \\ & 25 \\ & 10 \end{aligned}$ | 5.25 5.25 22 27 8 6 115.5 142 42 31.5 | V <br> V <br> mA <br> mA <br> mA <br> $\mu \mathrm{A}$ <br> mW <br> mW <br> mW <br> $\mu \mathrm{W}$ |

[^0]
## AD7607

## TIMING SPECIFICATIONS

$\mathrm{AV}_{\mathrm{CC}}=4.75 \mathrm{~V}$ to $5.25 \mathrm{~V}, \mathrm{~V}_{\text {DRIVE }}=2.3 \mathrm{~V}$ to $5.25 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=2.5 \mathrm{~V}$ external reference/internal reference, $\mathrm{T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{MIN}}$ to $\mathrm{T}_{\mathrm{MAX}}$, unless otherwise noted. ${ }^{1}$
Table 3.



| Parameter | Limit at $\mathrm{T}_{\text {min, }} \mathrm{T}_{\text {max }}$ |  |  | Unit | Description |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Min | Typ | Max |  |  |
| $\mathrm{t}_{27}$ |  |  |  |  | Delay from $\overline{\mathrm{RD}}$ falling edge to FRSTDATA low |
|  |  |  | 19 | ns | $V_{\text {drive }}=3.3 \mathrm{~V}$ to 5.25 V |
|  |  |  | 24 | ns | $V_{\text {DRIVE }}=2.3 \mathrm{~V}$ to 2.7 V |
| $\mathrm{t}_{28}$ |  |  |  |  | Delay from $16^{\text {th }}$ SCLK falling edge to FRSTDATA low |
|  |  |  | 17 | ns | $V_{\text {DRIVE }}=3.3 \mathrm{~V}$ to 5.25 V |
|  |  |  | 22 | ns | $V_{\text {DRIVE }}=2.3 \mathrm{~V}$ to 2.7 V |
| $\mathrm{t}_{29}$ |  |  | 24 | ns | Delay from $\overline{\mathrm{CS}}$ rising edge until FRSTDATA three-state enabled |

${ }^{1}$ Sample tested during initial release to ensure compliance. All input signals are specified with $t_{R}=t_{F}=5 \mathrm{~ns}$ ( $10 \%$ to $90 \%$ of $V_{\text {DRIVE }}$ ) and timed from a voltage level of 1.6 V .
${ }^{2}$ The delay between the CONVST x signals was measured as the maximum time allowed while ensuring a $<3$ LSB performance matching between channel sets.
${ }^{3} \mathrm{~A}$ buffer, which is equivalent to a load of 20 pF on the output pins, is used on the data output pins for these measurements.

## Timing Diagrams



Figure 2. CONVST Timing—Reading After a Conversion


Figure 3. CONVST Timing—Reading During a Conversion


Figure 4. Parallel Mode, Separate $\overline{C S}$ and $\overline{R D}$ Pulses


Figure 6. Serial Read Operation (Channel 1)


Figure 7. BYTE Mode Read Operation

## ABSOLUTE MAXIMUM RATINGS

$\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted.
Table 4.

| Parameter | Rating |
| :---: | :---: |
| AV $\mathrm{cc}^{\text {to }}$ AGND | -0.3 V to +7V |
| Vorive to AGND | -0.3 V to $\mathrm{AV} \mathrm{cc}+0.3 \mathrm{~V}$ |
| Analog Input Voltage to AGND ${ }^{1}$ | $\pm 16.5 \mathrm{~V}$ |
| Digital Input Voltage to AGND | -0.3 V to $\mathrm{V}_{\text {DRIVE }}+0.3 \mathrm{~V}$ |
| Digital Output Voltage to AGND | -0.3 V to $\mathrm{V}_{\text {dRIV }}+0.3 \mathrm{~V}$ |
| REFIN to AGND | -0.3 V to $\mathrm{AV}_{\mathrm{cc}}+0.3 \mathrm{~V}$ |
| Input Current to Any Pin Except Supplies ${ }^{1}$ | $\pm 10 \mathrm{~mA}$ |
| Operating Temperature Range |  |
| B Version | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ |
| Storage Temperature Range | $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Junction Temperature | $150^{\circ} \mathrm{C}$ |
| $\mathrm{Pb} / \mathrm{SN}$ Temperature, Soldering Reflow ( 10 sec to 30 sec ) | $240(+0)^{\circ} \mathrm{C}$ |
| Pb-Free Temperature, Soldering Reflow | $260(+0)^{\circ} \mathrm{C}$ |
| ESD (All Pins Except Analog Inputs) | 2 kV |
| ESD (Analog Input Pins Only) | 7 kV |

${ }^{1}$ Transient currents of up to 100 mA do not cause SCR latch-up.
Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational section of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

## THERMAL RESISTANCE

$\theta_{\text {IA }}$ is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages. These specifications apply to a 4-layer board.

Table 5. Thermal Resistance

| Package Type | $\boldsymbol{\theta}_{\mathbf{J A}}$ | $\boldsymbol{\theta}_{\mathrm{Jc}}$ | Unit |
| :--- | :--- | :--- | :--- |
| 64-Lead LQFP | 45 | 11 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATION AND FUNCTION DESCRIPTIONS



Table 6. Pin Function Descriptions

| Pin No. | Type ${ }^{1}$ | Mnemonic | Description |
| :---: | :---: | :---: | :---: |
| 1, 37, 38, 48 | P | $\mathrm{AV}_{\mathrm{cc}}$ | Analog Supply Voltage, 4.75 V to 5.25 V . This supply voltage is applied to the internal front-end amplifiers and to the ADC core. These supply pins should be decoupled to AGND. |
| $\begin{aligned} & 2,26,35,40, \\ & 41,47 \end{aligned}$ | P | AGND | Analog Ground. These pins are the ground reference points for all analog circuitry on the AD7607. All analog input signals and external reference signals should be referred to these pins. All six of these AGND pins should connect to the AGND plane of a system. |
| 5, 4, 3 | DI | OS[2:0] | Oversampling Mode Pins. Logic inputs. These inputs are used to select the oversampling ratio. OS 2 is the MSB control bit, and OS 0 is the LSB control bit. See the Digital Filter section for more details about the oversampling mode of operation and Table 9 for oversampling bit decoding. |
| 6 | DI | $\overline{\text { PAR/SER/ }}$ BYTE SEL | Parallel/Serial/Byte Interface Selection Input. Logic input. If this pin is tied to a logic low, the parallel interface is selected. If this pin is tied to a logic high, the serial interface is selected. Parallel byte interface mode is selected when this pin is logic high and DB15/BYTE SEL is logic high (see Table 8). In serial mode, the $\overline{\mathrm{RD}} / \mathrm{SCLK}$ pin functions as the serial clock input. The DB7/DoutA pin and the DB8/DourB pin function as serial data outputs. When the serial interface is selected, the DB[15:9] and $\mathrm{DB}[6: 0]$ pins should be tied to ground. <br> In byte mode, DB15, in conjunction with $\overline{P A R} / S E R / B Y T E ~ S E L$, is used to select the parallel byte mode of operation (see Table 8). DB14 is used as the HBEN pin. DB[7:0] transfer the 16-bit conversion results in two $\overline{\text { RD }}$ operations, with DB0 as the LSB of the data transfers. |
| 7 | DI | $\overline{\text { STBY }}$ | Standby Mode Input. This pin is used to place the AD7607 into one of two power-down modes: standby mode or shutdown mode. The power-down mode entered depends on the state of the RANGE pin, as shown in Table 7. When in standby mode, all circuitry, except the on-chip reference, regulators, and regulator buffers, is powered down. When in shutdown mode, all circuitry is powered down. |
| 8 | DI | RANGE | Analog Input Range Selection. Logic input. The polarity on this pin determines the input range of the analog input channels. If this pin is tied to a logic high, the analog input range is $\pm 10 \mathrm{~V}$ for all channels. If this pin is tied to a logic low, the analog input range is $\pm 5 \mathrm{~V}$ for all channels. A logic change on this pin has an immediate effect on the analog input range. Changing this pin during a conversion is not recommended. See the Analog Input section for more information. |


| Pin No. | Type ${ }^{1}$ | Mnemonic | Description |
| :---: | :---: | :---: | :---: |
| 9, 10 | DI | CONVST A, CONVST B | Conversion Start Input A, Conversion Start Input B. Logic inputs. These logic inputs are used to initiate conversions on the analog input channels. For simultaneous sampling of all 8 input channels CONVST A and CONVST B can be shorted together and a single convert start signal applied. <br> Alternatively, CONVST A can be used to initiate simultaneous sampling for $\mathrm{V} 1, \mathrm{~V} 2, \mathrm{~V} 3$, and V 4 ; and CONVST B can be used to initiate simultaneous sampling on the other analog inputs (V5, V6, V7, and V 8 ). This is possible only when oversampling is not switched on. <br> When the CONVST A or CONVST B pin transitions from low to high, the front-end track-and-hold circuitry for their respective analog inputs is set to hold. |
| 11 | DI | RESET | Reset Input. When set to logic high, the rising edge of RESET resets the AD7607. The part should receive a RESET pulse after power-up. The RESET high pulse should typically be 50 ns wide. If a RESET pulse is applied during a conversion, the conversion is aborted. If a RESET pulse is applied during a read, the contents of the output registers reset to all zeros. |
| 12 | DI | $\overline{\mathrm{RD}} / \mathrm{SCLK}$ | Parallel Data Read Control Input When the Parallel Interface Is Selected ( $\overline{\mathrm{RD}}) /$ Serial Clock Input When the Serial Interface is Selected (SCLK). When both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are logic low in parallel mode, the output bus is enabled. In serial mode, this pin acts as the serial clock input for data transfers. The $\overline{C S}$ falling edge takes the DoutA and DoutB data output lines out of tristate and clocks out the MSB of the conversion result. The rising edge of SCLK clocks all subsequent data bits onto the DoutA and DoutB serial data outputs. For more information, see the Conversion Control section. |
| 13 | DI | $\overline{C S}$ | Chip Select. This active low logic input frames the data transfer. When both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are logic low in parallel mode, the $\mathrm{DB}[15: 0]$ output bus is enabled and the conversion result is output on the parallel data bus lines. In serial mode, $\overline{C S}$ is used to frame the serial read transfer and clock out the MSB of the serial output data. |
| 14 | DO | BUSY | Busy Output. This pin transitions to a logic high after both CONVST A and CONVST B rising edges and indicates that the conversion process has started. The BUSY output remains high until the conversion process for all channels is complete. The falling edge of BUSY signals that the conversion data is being latched into the output data registers and is available to read after a Time $\mathrm{t}_{4}$. Any data read while BUSY is high must be completed before the falling edge of BUSY occurs. Rising edges on CONVST A or CONVST B have no effect while the BUSY signal is high. |
| 15 | DO | FRSTDATA | Digital Output. The FRSTDATA output signal indicates when the first channel, V 1 , is being read back on the parallel, parallel byte, or serial interface. When the $\overline{C S}$ input is high, the FRSTDATA output pin is in three-state. The falling edge of $\overline{C S}$ takes FRSTDATA out of three-state. In parallel mode, the falling edge of $\overline{\mathrm{RD}}$ corresponding to the result of V1 then sets the FRSTDATA pin high, which indicates that the result from V1 is available on the output data bus. The FRSTDATA output returns to a logic low following the next falling edge of $\overline{\mathrm{RD}}$. In serial mode, FRSTDATA goes high on the falling edge of $\overline{C S}$ because this clocks out the MSB of V1 on DouTA. It returns low on the $14^{\text {th }}$ SCLK falling edge after the $\overline{C S}$ falling edge. See the Conversion Control section for more details. |
| 22 to 16 | DO | DB[6:0] | Parallel Output Data Bits, DB6 to DB0. When $\overline{P A R} /$ SER/BYTE SEL $=0$, these pins act as three-state parallel digital input/output pins. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are low, these pins are used to output DB6 to DBO of the conversion result. When $\overline{\mathrm{PAR}} / \mathrm{SER} / \mathrm{BYTE}$ SEL $=1$, these pins should be tied to DGND. When operating in parallel byte interface mode, $\mathrm{DB}[7: 0]$ outputs the 14 -bit conversion result in two $\overline{\mathrm{RD}}$ operations. DB7 is the MSB, and DBO is the LSB. |
| 23 | P | $V_{\text {drive }}$ | Logic Power Supply Input. The voltage ( 2.3 V to 5.25 V ) supplied at this pin determines the operating voltage of the interface. This pin is nominally at the same supply as the supply of the host interface (that is, DSP and FPGA). |
| 24 | DO | DB7/DoutA | Parallel Output Data Bit 7 (DB7)/Serial Interface Data Output Pin (DoutA). When $\overline{\text { PAR }} / \mathrm{SER} / \mathrm{BYTE}$ SEL $=0$, this pins acts as a three-state parallel digital input/ output pin. When $\overline{C S}$ and $\overline{R D}$ are low, this pin is used to output DB7 of the conversion result. When $\overline{\mathrm{PAR}} / \mathrm{SER} / \mathrm{BYTE}$ SEL $=1$, this pin functions as DoutA and outputs serial conversion data (see the Conversion Control section for more details). When operating in parallel byte mode, DB7 is the MSB of the byte. |
| 25 | DO | DB8/DoutB | Parallel Output Data Bit 8 (DB8)/Serial Interface Data Output Pin (DoutB). When $\overline{\text { PAR }} / \mathrm{SER} / \mathrm{BYTE}$ SEL $=0$, this pin acts as a three-state parallel digital input/output pin. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are low, this pin is used to output DB8 of the conversion result. When $\overline{\mathrm{PAR}} / \mathrm{SER} / \mathrm{BYTE}$ SEL $=1$, this pin functions as Dout $B$ and outputs serial conversion data (see the Conversion Control section for more details). |
| 31 to 27 | DO | DB[13:9] | Parallel Output Data Bits, DB13 to DB9. When $\overline{\text { PAR }} /$ SER/BYTE SEL $=0$, these pins act as three-state parallel digital input/output pins. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are low, these pins are used to output DB13 to DB9 of the conversion result. When $\overline{\mathrm{PAR}} / \mathrm{SER} / \mathrm{BYTE}$ SEL $=1$, these pins should be tied to DGND. |


| Pin No. | Type ${ }^{1}$ | Mnemonic | Description |
| :---: | :---: | :---: | :---: |
| 32 | DO/DI | DB14/HBEN | Parallel Output Data Bit 14 (DB14)/High Byte Enable (HBEN). When $\overline{\text { PAR } / S E R / B Y T E ~ S E L ~}=0$, this pin acts as a three-state parallel digital output pin. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are low, this pin is used to output DB14 of the conversion result, which is a sign extended bit of the MSB, DB13. When $\overline{\text { PAR }} / \mathrm{SER} / \mathrm{BYTE}$ SEL = 1 and DB15/BYTE SEL = 1, the AD7607 operates in parallel byte interface mode, in which the HBEN pin is used to select if the most significant byte (MSB) or the least significant byte (LSB) of the conversion result is output first. When HBEN $=1$, the MSB byte is output first, followed by the LSB byte. When HBEN $=0$, the LSB byte is output first, followed by the MSB byte. |
| 33 | DO/DI | DB15/ <br> BYTE SEL | Parallel Output Data Bit 15 (DB15)/Parallel Byte Mode Select (BYTE SEL). When $\overline{\text { PAR } / S E R / B Y T E ~ S E L ~}=$ 0 , this pin acts as a three-state parallel digital output pin. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are low, this pin is used to output DB15, which is a sign extended bit of the MSB, DB13, of the conversion result. When $\overline{\text { PAR } / ~}$ SER/BYTE SEL = 1, the BYTE SEL pin is used to select between serial interface mode or parallel byte interface mode (see Table 8). When $\overline{\text { PAR }} / \mathrm{SER} / \mathrm{BYTE}$ SEL $=1$ and DB15/BYTE SEL $=0$, the AD7607 operates in serial interface mode. When $\overline{\text { PAR }} / \mathrm{SER} / \mathrm{BYTE}$ SEL $=1$ and DB15/BYTE SEL $=1$, the AD7607 operates in parallel byte interface mode. |
| 34 | DI | REF SELECT | Internal/External Reference Selection Input. Logic input. If this pin is set to logic high, the internal reference is selected and enabled. If this pin is set to logic low, the internal reference is disabled and an external reference voltage must be applied to the REFIN/REFOUT pin. |
| 36,39 | P | REGCAP | Decoupling Capacitor Pin for Voltage Output from Internal Regulator. These output pins should be decoupled separately to AGND using a $1 \mu \mathrm{~F}$ capacitor. The voltage on these pins is in the range of 2.5 V to 2.7 V . |
| 42 | REF | REFIN/ REFOUT | Reference Input (REFIN)/Reference Output (REFOUT). The gained up on-chip reference of 2.5 V is available on this pin for external use if the REF SELECT pin is set to a logic high. Alternatively, the internal reference can be disabled by setting the REF SELECT pin to a logic low, and an external reference of 2.5 V can be applied to this input (see the Internal/External Reference section). Decoupling is required on this pin for both the internal or external reference options. A $10 \mu \mathrm{~F}$ capacitor should be applied from this pin to ground close to the REFGND pins. |
| 43,46 | REF | REFGND | Reference Ground Pins. These pins should be connected to AGND. |
| 44,45 | REF | REFCAPA, REFCAPB | Reference Buffer Output Force/Sense Pins. These pins must be connected together and decoupled to AGND using a low ESR $10 \mu \mathrm{~F}$ ceramic capacitor. |
| $\begin{aligned} & 49,51,53, \\ & 55,57,59, \\ & 61,63 \end{aligned}$ | AI | V1 to V8 | Analog Inputs. These pins are single-ended analog inputs. The analog input range of these channels is determined by the RANGE pin. |
| $\begin{aligned} & 50,52,54, \\ & 56,58,60, \\ & 62,64 \end{aligned}$ | AI GND | V1GND to V8GND | Analog Input Ground Pins. These pins correspond to Analog Input Pin V1 to Analog Input Pin V8. All analog input AGND pins should connect to the AGND plane of a system. |

[^1]
## TYPICAL PERFORMANCE CHARACTERISTICS



Figure 9. FFT $\pm 10 \mathrm{~V}$ Range


Figure 10. FFT Plot $\pm 5$ V Range


Figure 11. Typical INL $\pm 10$ V Range


Figure 12. Typical DNL $\pm 10$ V Range


Figure 13. Typical INL $\pm 5$ V Range


Figure 14. Typical DNL $\pm 5$ V Range


Figure 15. NFS Error vs. Temperature


Figure 16. PFS Error vs. Temperature


Figure 17. PFS and NFS Error Matching vs. Temperature


Figure 18. PFS and NFS Error vs. Source Resistance


Figure 19. SNR vs. Input Frequency $\pm 5$ V Range


Figure 20. SNR vs. Input Frequency $\pm 10$ V Range


Figure 21. Bipolar Zero Code Error vs. Temperature


Figure 22. Bipolar Zero Code Error Matching vs. Temperature


Figure 23. THD vs. Input Frequency for Various Source Impedances, $\pm 10$ V Range


Figure 24. THD vs. Input Frequency for Various Source Impedances, $\pm 5$ V Range


Figure 25. Reference Output Voltage vs. Temperature for Different Supply Voltages


Figure 26. Analog Input Current vs. Input Voltage for Various Temperatures


Figure 27. Supply Current vs. Oversampling Rate


Figure 28. PSRR


Figure 29. Channel-to-Channel Isolation

## TERMINOLOGY

## Integral Nonlinearity

The maximum deviation from a straight line passing through the endpoints of the ADC transfer function. The endpoints of the transfer function are zero scale, at $1 / 2$ LSB below the first code transition; and full scale, at $1 / 2$ LSB above the last code transition.

## Differential Nonlinearity

The difference between the measured and the ideal 1 LSB change between any two adjacent codes in the ADC.

## Bipolar Zero Code Error

The deviation of the midscale transition (all 1s to all 0 s) from the ideal, which is $0 \mathrm{~V}-1 / 2 \mathrm{LSB}$.

## Bipolar Zero Code Error Match

The absolute difference in bipolar zero code error between any two input channels.

## Positive Full-Scale Error

The deviation of the actual last code transition from the ideal last code transition ( $10 \mathrm{~V}-1 \frac{1}{2} \mathrm{LSB}$ (9.998) and $5 \mathrm{~V}-1^{1 ⁄ 2} \mathrm{LSB}$ (4.99908)) after bipolar zero code error is adjusted out. The positive full-scale error includes the contribution from the internal reference buffer.

## Positive Full-Scale Error Match

The absolute difference in positive full-scale error between any two input channels.

## Negative Full-Scale Error

The deviation of the first code transition from the ideal first code transition ( $-10 \mathrm{~V}+1 / 2 \mathrm{LSB}(-9.9993$ ) and $-5 \mathrm{~V}+1 / 2 \mathrm{LSB}$ (-4.99969)) after the bipolar zero code error is adjusted out. The negative full-scale error includes the contribution from the internal reference buffer.

## Negative Full-Scale Error Match

The absolute difference in negative full-scale error between any two input channels.

## Signal-to-(Noise + Distortion) Ratio

The measured ratio of signal-to-(noise + distortion) at the output of the ADC. The signal is the rms amplitude of the fundamental. Noise is the sum of all nonfundamental signals up to half the sampling frequency ( $\mathrm{f}_{\mathrm{s}} / 2$, excluding dc ).

The ratio depends on the number of quantization levels in the digitization process: the more levels, the smaller the quantization noise.
The theoretical signal-to-(noise + distortion) ratio for an ideal N -bit converter with a sine wave input is given by

$$
\text { Signal-to-(Noise }+ \text { Distortion })=(6.02 N+1.76) \mathrm{dB}
$$

Thus, for a 14-bit converter, the signal-to-(noise + distortion) is 86.04 dB .

## Total Harmonic Distortion (THD)

The ratio of the rms sum of the harmonics to the fundamental. For the AD7607, it is defined as

$$
\begin{aligned}
& \operatorname{THD}(\mathrm{dB})= \\
& 20 \log \frac{\sqrt{V_{2}{ }^{2}+V_{3}^{2}+V_{4}^{2}+V_{5}^{2}+V_{6}{ }^{2}+V_{7}^{2}+V_{8}^{2}+V_{9}{ }^{2}}}{V_{1}}
\end{aligned}
$$

where:
$V_{1}$ is the rms amplitude of the fundamental.
$V_{2}$ to $V_{9}$ are the rms amplitudes of the second through ninth harmonics.

## Peak Harmonic or Spurious Noise

The ratio of the rms value of the next largest component in the ADC output spectrum (up to $f_{s} / 2$, excluding dc) to the rms value of the fundamental. Normally, the value of this specification is determined by the largest harmonic in the spectrum, but for ADCs where the harmonics are buried in the noise floor, it is determined by a noise peak.

## Intermodulation Distortion

With inputs consisting of sine waves at two frequencies, fa and fb , any active device with nonlinearities create distortion products at sum and difference frequencies of $\mathrm{mfa} \pm \mathrm{nfb}$, where $\mathrm{m}, \mathrm{n}=0$, $1,2,3$. Intermodulation distortion terms are those for which neither $m$ nor $n$ is equal to 0 . For example, the second-order terms include ( $\mathrm{fa}+\mathrm{fb}$ ) and ( $\mathrm{fa}-\mathrm{fb}$ ), and the third-order terms include $(2 \mathrm{fa}+\mathrm{fb})$, $(2 \mathrm{fa}-\mathrm{fb}),(\mathrm{fa}+2 \mathrm{fb})$, and $(\mathrm{fa}-2 \mathrm{fb})$.

The calculation of the intermodulation distortion is per the THD specification, where it is the ratio of the rms sum of the individual distortion products to the rms amplitude of the sum of the fundamentals expressed in decibels (dB).
Power Supply Rejection Ratio (PSRR)
Variations in power supply affect the full-scale transition but not the linearity of the converter. PSR is the maximum change in full-scale transition point due to a change in power supply voltage from the nominal value. The PSR ratio (PSRR) is defined as the ratio of the power in the ADC output at full-scale frequency, f , to the power of a 200 mV p-p sine wave applied to the ADC's $V_{D D}$ and $V_{S S}$ supplies of frequency, $\mathrm{f}_{\mathrm{s}}$.

$$
P S R R(\mathrm{~dB})=10 \log \left(P f / P f_{s}\right)
$$

where:
$P f$ is equal to the power at Frequency $f$ in the $\operatorname{ADC}$ output. $P f_{s}$ is equal to the power at Frequency $f_{s}$ coupled onto the $A V_{c c}$ supplies.

## Channel-to-Channel Isolation

Channel-to-channel isolation is a measure of the level of crosstalk between any two channels. It is measured by applying a full-scale sine wave signal of up to 160 kHz to all unselected input channels, and then determining the degree to which the signal attenuates in the selected channel with a 1 kHz sine wave signal applied (see Figure 29).

## THEORY OF OPERATION

## CONVERTER DETAILS

The AD7607 is a data acquisition system that employs a high speed, low power, charge redistribution, successive approximation analog-to-digital converter (ADC) and allows the simultaneous sampling of eight analog input channels. The analog inputs on the AD7607 can accept true bipolar input signals. The RANGE pin is used to select either $\pm 10 \mathrm{~V}$ or $\pm 5 \mathrm{~V}$ as the input range. The AD7607 operates from a single 5 V supply.

The AD7607 contains input clamp protection, input signal scaling amplifiers, a second-order antialiasing filter, track-and-hold amplifiers, an on-chip reference, reference buffers, a high speed ADC, a digital filter, and high speed parallel and serial interfaces. Sampling on the AD7607 is controlled using the CONVST signals.

## ANALOG INPUT

## Analog Input Ranges

The AD7607 can handle true bipolar input voltages. The logic level on the RANGE pin determines the analog input range of all analog input channels. If this pin is tied to a logic high, the analog input range is $\pm 10 \mathrm{~V}$ for all channels. If this pin is tied to a logic low, the analog input range is $\pm 5 \mathrm{~V}$ for all channels. A logic change on this pin has an immediate effect on the analog input range; however, there is a typical settling time of $\sim 80 \mu \mathrm{~s}$, in addition to the normal acquisition time requirement. Recommended practice is to hardwire the RANGE pin according to the desired input range for the system signals.
During normal operation, the applied analog input voltage should remain within the analog input range selected via the range pin. A RESET pulse must be applied after power-up to ensure the analog input channels are configured for the range selected.

When in a power-down mode, it is recommended to tie the analog inputs to GND. As per the input clamp protection section, the overvoltage clamp protection is recommended for use in transient overvoltage conditions and should not remain active for extended periods. Stressing the analog inputs outside of the conditions mentioned here may degrade the Bipolar Zero Code error and THD performance of the AD7607.

## Analog Input Impedance

The analog input impedance of the AD7607 is $1 \mathrm{M} \Omega$. This is a fixed input impedance that does not vary with the AD7607 sampling frequency. This high analog input impedance eliminates the need for a driver amplifier in front of the AD7607, allowing for direct connection to the source or sensor. With the need for a driver amplifier eliminated, bipolar supplies (which are often a source of noise in a system) can be removed from the signal chain.

## Analog Input Clamp Protection

Figure 30 shows the analog input structure of the AD7607. Each AD7607 analog input contains clamp protection circuitry. Despite single 5 V supply operation, this analog input clamp protection allows for an input overvoltage of up to $\pm 16.5 \mathrm{~V}$.


Figure 30. Analog Input Circuitry
Figure 31 shows the voltage vs. current characteristic of the clamp circuit. For input voltages of up to $\pm 16.5 \mathrm{~V}$, no current flows in the clamp circuit. For input voltages that are above $\pm 16.5 \mathrm{~V}$, the AD7607 clamp circuitry turns on and clamps the analog input to $\pm 16.5 \mathrm{~V}$.


Figure 31. Input Protection Clamp Profile
A series resistor should be placed on the analog input channels to limit the current to $\pm 10 \mathrm{~mA}$ for input voltages above $\pm 16.5 \mathrm{~V}$. In an application where there is a series resistance on an analog input channel, Vx , a corresponding resistance is required on the analog input GND channel, VxGND (see Figure 32). If there is no corresponding resistor on the VxGND channel, an offset error occurs on that channel.


Figure 32. Input Resistance Matching on the Analog Input

## Analog Input Antialiasing Filter

An analog antialiasing filter (a second-order Butterworth) is also provided on the AD7607. Figure 33 and Figure 34 show the frequency and phase response, respectively, of the analog antialiasing filter. In the $\pm 5 \mathrm{~V}$ range, the -3 dB frequency is typically 15 kHz . In the $\pm 10 \mathrm{~V}$ range, the -3 dB frequency is typically 23 kHz .


Figure 33. Analog Antialiasing Filter Frequency Response


Figure 34. Analog Antialiasing Filter Phase Response

## Track-and-Hold Amplifiers

The track-and-hold amplifiers on the AD7607 let the ADC accurately acquire an input sine wave of full-scale amplitude to 14-bit resolution. The track-and-hold amplifiers sample their respective inputs simultaneously on the rising edge of CONVST x . The aperture time for the track-and-hold (that is, the delay time between the external CONVST x signal and the track-and-hold actually going into hold) is well matched, by design, across all eight track-and-holds on one device and from device to device. This matching allows more than one AD7607 device to be sampled simultaneously in a system.

The end of the conversion process across all eight channels is indicated by the falling edge of BUSY, and it is at this point that the track-and-holds return to track mode and the acquisition time for the next set of conversions begins.
The conversion clock for the part is internally generated, and the conversion time for all channels is $4 \mu \mathrm{~s}$. On the AD7607, the BUSY signal returns low after all eight conversions to indicate the end of the conversion process. On the falling edge of BUSY, the track-and-hold amplifiers return to track mode. New data can be read from the output register via the parallel, parallel byte, or serial interface after BUSY goes low; or, alternatively, data from the previous conversion can be read while BUSY is high. Reading data from the AD7607 while a conversion is in progress has little effect on performance and allows a faster throughput to be achieved. In parallel mode at $\mathrm{V}_{\text {DRIVE }}>3.3 \mathrm{~V}$, the SNR is reduced by $\sim 1.5 \mathrm{~dB}$ when reading during a conversion.

## ADC TRANSFER FUNCTION

The output coding of the AD7607 is twos complement. The designed code transitions occur midway between successive integer LSB values, that is, $1 / 2$ LSB, $3 / 2$ LSB. The LSB size is FSR/16,384. The ideal transfer characteristic is shown in Figure 35.


Figure 35. Transfer Characteristics
The LSB size is dependent on the analog input range selected.

## INTERNAL/EXTERNAL REFERENCE

The AD7607 contains an on-chip 2.5 V bandgap reference. The REFIN/REFOUT pin allows access to the 2.5 V reference that generates the on-chip 4.5 V reference internally, or it allows an external reference of 2.5 V to be applied to the AD7607. An externally applied reference of 2.5 V is also gained up to 4.5 V , using the internal buffer. This 4.5 V buffered reference is the reference used by the SAR ADC.
The REF SELECT pin is a logic input pin that allows the user to select between the internal reference or an external reference. If this pin is set to logic high, the internal reference is selected and enabled. If this pin is set to logic low, the internal reference is disabled and an external reference voltage must be applied to the REFIN/REFOUT pin. The internal reference buffer is always enabled. After a reset, the AD7607 operates in the reference mode selected by the REF SELECT pin. Decoupling is required on the REFIN/REFOUT pin for both the internal and external reference options. A $10 \mu \mathrm{~F}$ ceramic capacitor is required on the REFIN/REFOUT pin.
The AD7607 contains a reference buffer configured to gain the REF voltage up to $\sim 4.5 \mathrm{~V}$, as shown in Figure 36. The REFCAPA and REFCAPB pins must be shorted together externally, and a ceramic capacitor of $10 \mu \mathrm{~F}$ applied to REFGND, to ensure that the reference buffer is in closed-loop operation. The reference voltage available at the REFIN/REFOUT pin is 2.5 V .

When the AD7607 is configured in external reference mode, the REFIN/REFOUT pin is a high input impedance pin. For applications using multiple AD7607 devices, the following configurations are recommended, depending on the application requirements.

## External Reference Mode

One ADR421 external reference can be used to drive the REFIN/REFOUT pins of all AD7607 devices (see Figure 37). In this configuration, each REFIN/REFOUT pin of the AD7607 should be decoupled with a 100 nF decoupling capacitor.

## Internal Reference Mode

One AD7607 device, configured to operate in the internal reference mode, can be used to drive the remaining AD7607 devices, which are configured to operate in external reference mode (see Figure 38). The REFIN/REFOUT pin of the AD7607, configured in internal reference mode, should be decoupled using a $10 \mu \mathrm{~F}$ ceramic decoupling capacitor. The other AD7607 devices, configured in external reference mode, should use a 100 nF decoupling capacitor on their REFIN/REFOUT pins.


Figure 36. Reference Circuitry


Figure 37. Single External Reference Driving Multiple AD7607 REFIN Pins


Figure 38. Internal Reference Driving Multiple AD7607 REFIN Pins.

## TYPICAL CONNECTION DIAGRAM

Figure 39 shows the typical connection diagram for the AD7607. There are four AVCC supply pins on the part, and each of the four pins should be decoupled using a 100 nF capacitor at each supply pin and a $10 \mu \mathrm{~F}$ capacitor at the supply source. The AD7607 can operate with the internal reference or an externally applied reference. In this configuration, the AD7607 is configured to operate with the internal reference. When using a single AD7607 device on the board, the REFIN/REFOUT pin should be decoupled with a $10 \mu \mathrm{~F}$ capacitor. When using an application with multiple AD7607 devices, refer to the Internal/External Reference section. The REFCAPA and REFCAPB pins are shorted together and decoupled with a $10 \mu \mathrm{~F}$ ceramic capacitor.
The $V_{\text {DRIVE }}$ supply is connected to the same supply as the processor. The $V_{\text {DRIVE }}$ voltage controls the voltage value of the output logic signals. For layout, decoupling, and grounding hints, see the Layout Guidelines section.

## POWER-DOWN MODES

Two power-down modes are available on the AD7607: standby mode and shutdown mode. The $\overline{\text { STBY }}$ pin controls whether the AD7607 is in normal mode or in one of the two powerdown modes.

${ }^{1}$ DECOUPLING SHOWN ON THE AV ${ }_{C C}$ PIN APPLIES TO EACH AV ${ }_{C C}$ PIN (PIN 1, PIN 37, PIN 38, PIN 48). DECOUPLING CAPACITOR CAN BE SHARED BETWEEN AV ${ }_{\text {Cc }}$ PIN 37 AND PIN 38. ${ }^{2}$ DECOUPLING SHOWN ON THE REGCAP PIN APPLIES TO EACH REGCAP PIN (PIN 36, PIN 39).

Figure 39. Typical Connection Diagram

## CONVERSION CONTROL

## Simultaneous Sampling on All Analog Input Channels

The AD7607 allows simultaneous sampling of all analog input channels. All channels are sampled simultaneously when both CONVST pins (CONVST A, CONVST B) are tied together. A single CONVST signal is used to control both CONVST $x$ inputs. The rising edge of this common CONVST signal initiates simultaneous sampling on all analog input channels.

The AD7607 contains an on-chip oscillator that is used to perform the conversions. The conversion time for all ADC channels is tconv. The BUSY signal indicates to the user when conversions are in progress, so when the rising edge of CONVST is applied, BUSY goes logic high and transitions low at the end of the entire conversion process. The falling edge of the BUSY signal is used to place all eight track-and-hold amplifiers back into track mode. The falling edge of BUSY also indicates that the new data can now be read from the parallel bus ( $\mathrm{DB}[15: 0]$ ), the $D_{\text {out }} A$ and $D_{\text {out }} B$ serial data lines, or the parallel byte bus ( $\mathrm{DB}[7: 0]$ ).

## Simultaneously Sampling Two Sets of Channels

The AD7607 also allows the analog input channels to be sampled simultaneously in two sets. This can be used in power-line protection and measurement systems to compensate for phase differences between current and voltage sensors. In a 50 Hz system, this allows for up to $9^{\circ}$ of phase compensation; and in a 60 Hz system, it allows for up to $10^{\circ}$ of phase compensation.

This is accomplished by pulsing the two CONVST pins independently and is possible only if oversampling is not in use. CONVST A is used to initiate simultaneous sampling of the first set of channels (V1 to V4), and CONVST B is used to initiate simultaneous sampling on the second set of analog input channels (V5 to V8), as illustrated in Figure 40.

On the rising edge of CONVST A, the track-and-hold amplifiers for the first set of channels are placed into hold mode. On the rising edge of CONVST B, the track-and-hold amplifiers for the second set of channels are placed into hold mode. The conversion process begins when both rising edges of CONVST $x$ have occurred; therefore, BUSY goes high on the rising edge of the later CONVST $x$ signal. In Table 3 , Time $t_{5}$ indicates the maximum allowable time between CONVST $x$ sampling points.
There is no change to the data read process when using two separate CONVST x signals.

Connect all unused analog input channels to AGND. The results for any unused channels are still included in the data read because all channels are always converted.


[^2]
## DIGITAL INTERFACE

The AD7607 provides three interface options: a parallel interface, a high speed serial interface, and a parallel byte interface. The required interface mode is selected via the PAR/SER/BYTE SEL and the DB15/BYTE SEL pins.

Table 8. Interface Mode Selection

| $\overline{\text { PAR/SER/BYTE SEL }}$ | DB15 | Interface Mode |
| :--- | :--- | :--- |
| 0 | 0 | Parallel interface mode |
| 1 | 0 | Serial interface mode |
| 1 | 1 | Parallel byte interface mode |

Interface mode operation is discussed in the following sections.

## PARALLEL INTERFACE ( $\overline{\text { PAR }} /$ SER/BYTE SEL = 0 )

Data can be read from the AD7607 via the parallel data bus with standard $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ signals. To read the data over the parallel bus, the $\overline{\mathrm{PAR}} / \mathrm{SER} / \mathrm{BYTE}$ SEL pin should be tied low. The $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ input signals are internally gated to enable the conversion result onto the data bus. The data lines, DB 15 to DB0, leave their high impedance state when both $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are logic low. When $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ are low, DB15 and DB14 are used to output a sign extended bit of the MSB (DB13) of the conversion result.


Figure 41. Interface Diagram-One AD7607 Using the Parallel Bus, with $\overline{C S}$ and $\overline{R D}$ Shorted Together
The rising edge of the $\overline{\mathrm{CS}}$ input signal tristates the bus, and the falling edge of the $\overline{\mathrm{CS}}$ input signal takes the bus out of the high impedance state. $\overline{\mathrm{CS}}$ is the control signal that enables the data lines; it is the function that allows multiple AD7607 devices to share the same parallel data bus.
The $\overline{\mathrm{CS}}$ signal can be permanently tied low, and the $\overline{\mathrm{RD}}$ signal can be used to access the conversion results as shown in Figure 4. A read operation of new data can take place after the BUSY signal goes low (see Figure 2); or, alternatively, a read operation of data from the previous conversion process can take place while BUSY is high (see Figure 3).
The $\overline{\mathrm{RD}}$ pin is used to read data from the output conversion results register. Applying a sequence of $\overline{\mathrm{RD}}$ pulses to the $\overline{\mathrm{RD}}$ pin of the AD7607 clocks the conversion results out from each channel onto the parallel output bus, DB [15:0], in ascending order. The first $\overline{\mathrm{RD}}$ falling edge after BUSY goes low clocks out the conversion result from Channel V1. The next $\overline{\mathrm{RD}}$ falling edge updates the bus with the V2 conversion result, and so on. The eighth falling edge of $\overline{\mathrm{RD}}$ clocks out the conversion result for Channel V8. When the $\overline{\mathrm{RD}}$ signal is logic low, it enables the data conversion result from each channel to be transferred to the digital host (DSP, FPGA).

When there is only one AD7607 in a system/board and it does not share the parallel bus, data can be read using just one control signal from the digital host. The $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ signals can be tied together, as shown in Figure 5. In this case, the data bus comes out of three-state on the falling edge of $\overline{\mathrm{CS}} / \overline{\mathrm{RD}}$. The combined $\overline{\mathrm{CS}}$ and $\overline{\mathrm{RD}}$ signal allows the data to be clocked out of the AD7607 and to be read by the digital host. In this case, $\overline{\mathrm{CS}}$ is used to frame the data transfer of each data channel.

## PARALLEL BYTE INTERFACE ( $\overline{\text { PAR/SER/BYTE SEL }=1 \text {, }, ~}$ DB15 = 1)

Parallel byte interface mode operates much like the parallel interface mode, except that each channel conversion result is read out in two 8 -bit transfers. Therefore, $16 \overline{\mathrm{RD}}$ pulses are required to read all eight conversion results from the AD7607. To configure the AD7607 to operate in parallel byte interface mode, the $\overline{\mathrm{PAR}} / \mathrm{SER} /$ BYTE SEL and BYTE SEL/DB15 pins should be tied to logic high (see Table 8). $\mathrm{DB}[7: 0]$ are used to transfer the data to the digital host. DB0 is the LSB of the data transfer, and DB7 is the MSB of the data transfer. In parallel byte mode, DB14 acts as an HBEN pin. When the DB14/HBEN pin is tied to logic high, the most significant byte (MSB) of the conversion result is output first, followed by the LSB byte of the conversion result. When DB14/HBEN is tied to logic low, the LSB byte of the conversion result is output first, followed by the MSB byte of the conversion result. The FRSTDATA pin remains high until the entire 14 bits of the conversion result from V1 is read. If the MSB byte is always to be read first, the HBEN pin should be set high and remain high. If the LSB byte is always to be read first, the HBEN pin should be set low and remain low. In this circumstance, the MSB byte contains two sign extended bits in the two MSB positions.

## SERIAL INTERFACE ( $\overline{\text { PAR }} /$ SER/BYTE SEL = 1)

To read data back from the AD7607 over the serial interface, the $\overline{\text { PAR }} /$ SER/BYTE SEL pin must be tied high. The $\overline{\mathrm{CS}}$ and SCLK signals are used to transfer data from the AD7607. The AD7607 has two serial data output pins, Dout A and DourB. Data can be read back from the AD7607 using one or both of these Dout lines. For the AD7607, conversion results from Channel V1 to Channel V4 first appear on Dout A, and conversion results from Channel V5 to Channel V8 first appear on DoutB.
The $\overline{\mathrm{CS}}$ falling edge takes the data output lines, $\mathrm{D}_{\text {out }} A$ and $\mathrm{D}_{\text {out }} \mathrm{B}$, out of three-state and clocks out the MSB of the conversion result. The rising edge of SCLK clocks all subsequent data bits onto the serial data outputs, DoutA and DoutB. The $\overline{\mathrm{CS}}$ input can be held low for the entire serial read, or it can be pulsed to frame each channel read of 14 SCLK cycles.

Figure 42 shows a read of eight simultaneous conversion results using two Dout lines on the AD7607. In this case, a 56 SCLK transfer is used to access data from the AD7607, and $\overline{\mathrm{CS}}$ is held low to frame the entire 56 SCLK cycles. Data can also be clocked out using just one Dout line; in which case, it is recommended that $D_{\text {out }}$ be used to access all conversion data because the channel data is output in ascending order. For the AD7607 to access all eight conversion results on one Dout line, a total of 112 SCLK cycles are required. These 112 SCLK cycles can be framed by one $\overline{\mathrm{CS}}$ signal, or each group of 14 SCLK cycles can be individually framed by the $\overline{\mathrm{CS}}$ signal. The disadvantage of using just one Dout line is that the throughput rate is reduced if reading occurs after conversion. The unused Dout line should be left unconnected in serial mode. If $\mathrm{D}_{\text {out }} \mathrm{B}$ is to be used as a single Dout line, the channel results are output in the following order: V5, V6, V7, V8, V1, V2, V3, and V4; however, the FRSTDATA indicator returns low after V5 is read on DoutB.
Figure 6 shows the timing diagram for reading one channel of data, framed by the $\overline{\mathrm{CS}}$ signal, from the AD7607 in serial mode. The SCLK input signal provides the clock source for the serial read operation. The $\overline{\mathrm{CS}}$ goes low to access the data from the AD7607. The falling edge of $\overline{\mathrm{CS}}$ takes the bus out of three-state and clocks out the MSB of the 14 -bit conversion result. This MSB is valid on the first falling edge of the SCLK after the $\overline{\mathrm{CS}}$ falling edge.

The subsequent 13 data bits are clocked out of the AD 7607 on the SCLK rising edge. Data is valid on the SCLK falling edge. To access each conversion result, 14 clock cycles must be provided.
The FRSTDATA output signal indicates when the first channel, V 1 , is being read back. When the $\overline{\mathrm{CS}}$ input is high, the FRSTDATA output pin is in three-state. In serial mode, the falling edge of $\overline{\mathrm{CS}}$ takes FRSTDATA out of three-state and sets the FRSTDATA pin high, indicating that the result from V 1 is available on the Dour A output data line. The FRSTDATA output returns to a logic low following the $14^{\text {th }}$ SCLK falling edge. If all channels are read on DoutB, the FRSTDATA output does not go high when V1 is output on this serial data output pin. It goes high only when V1 is available on Dout A (and this is when V5 is available on DoutB).

## READING DURING CONVERSION

Data can be read from the AD7607 while BUSY is high and the conversions are in progress. This has little effect the performance of the converter, and it allows a faster throughput rate to be achieved. A parallel, parallel byte, or serial read can be performed during conversions and when oversampling is or is not enabled. Figure 3 shows the timing diagram for reading while BUSY is high in parallel or serial mode. Reading during conversions allows the full throughput rate to be achieved when using the serial interface with $V_{\text {drive }}$ above 3.3 V .
Data can be read from the AD7607 at any time other than on the falling edge of BUSY because this is when the output data registers get updated with the new conversion data. Time $t_{6}$, as outlined in Table 3, should be observed in this condition.


## DIGITAL FILTER

The AD7607 contains an optional first-order digital sinc filter that should be used in applications where slower throughput rates are used and digital filtering is required. The oversampling ratio of the digital filter is controlled using the oversampling pins, OS[2:0] (see Table 9). OS 2 is the MSB control bit, and OS 0 is the LSB control bit. Table 9 lists the oversampling bit decoding to select the
different oversample rates. The OS pins are latched on the falling edge of BUSY. This sets the oversampling rate for the next conversion (see Figure 43).
Selection of the oversampling mode has the effect of adding a digital filter function after the ADC. The different oversampling rates and the CONVST x sampling frequency produce different digital filter frequency profiles.

Table 9. Oversample Bit Decoding

| OS[2:0] | Oversampling Ratio | $\mathbf{3 ~ d B ~ B W , ~ 5 ~ V ~ R a n g e ~ ( k H z ) ~}$ | $\mathbf{3 ~ d B ~ B W , ~ 1 0 ~ V ~ R a n g e ~ ( k H z ) ~}$ | Maximum Throughput, <br> CONVST Frequency (kHz) |
| :--- | :--- | :--- | :--- | :--- |
| 000 | No oversampling | 15 | 22 | 200 |
| 001 | 2 | 15 | 22 | 100 |
| 010 | 4 | 13.7 | 18.5 | 50 |
| 011 | 8 | 10.3 | 11.9 | 25 |
| 100 | 16 | 6 | 6 | 12.5 |
| 101 | 32 | 3 | 3 | 6.25 |
| 110 | 64 | 1.5 | 1.5 | 3.125 |
| 111 | Invalid |  |  |  |



Figure 44 to Figure 49 show the digital filter frequency profiles for the different oversampling ratios. The combination of the analog antialiasing filter and the oversampling digital filter helps to reduce the complexity of the design of the filter before the AD7607. The digital filtering combines steep roll-off and linear phase response.


Figure 44. Digital Filter Response for Oversampling by 2


Figure 45. Digital Filter Response for Oversampling by 4


Figure 46. Digital Filter Response for Oversampling by 8


Figure 47. Digital Filter Response for Oversampling by 16


Figure 48. Digital Filter Response for Oversampling by 32


Figure 49. Digital Filter Response for Oversampling by 64


Figure 50. Histogram of Codes, Oversampling by 64
If the $\operatorname{OS}[2: 0]$ pins are set to select an oversampling ratio of 8 , for example, the next CONVST $x$ rising edge takes the first sample for each channel. The remaining seven samples for all channels are taken with an internally generated sampling signal. As the oversampling ratio is increased, the 3 dB frequency is reduced and the allowed sampling frequency is also reduced (see Table 9). The $\operatorname{OS}[2: 0]$ pins should be configured to suit the filtering requirements of the application.
The CONVST A and CONVST B pins must be tied/driven together when oversampling is turned on. When the oversampling function is turned on, the BUSY high time for the conversion
process extends. The actual BUSY high time depends on the oversampling rate that is selected: the higher the oversampling rate, the longer the BUSY high or total conversion time (see Table 3).
Figure 51 shows that the conversion time extends as the oversampling rate is increased. To achieve the fastest throughput rate possible when oversampling is turned on, the read can be performed during the BUSY high time. The falling edge of BUSY is used to update the output data registers with the new conversion data; therefore, the reading of conversion data should not occur on this edge.


Figure 51. No Oversampling, Oversampling by 4, and Oversampling by 8
Using Read After Conversion

## LAYOUT GUIDELINES

The printed circuit board that houses the AD7607 should be designed so that the analog and digital sections are separated and confined to different areas of the board.

At least one ground plane should be used. It can be common or split between the digital and analog sections. In the case of the split plane, the digital and analog ground planes should be joined in only one place, preferably as close as possible to the AD7607.
If the AD7607 is in a system where multiple devices require analog-to-digital ground connections, the connection should still be made at only one point: a star ground point that should be established as close as possible to the AD7607. Good connections should be made to the ground plane. Avoid sharing one connection for multiple ground pins. Use individual vias or multiple vias to the ground plane for each ground pin.

Avoid running digital lines under the devices because doing so couples noise onto the die. The analog ground plane should be allowed to run under the AD7607 to avoid noise coupling. Fast switching signals like CONVST A, CONVST B, or clocks should be shielded with digital ground to avoid radiating noise to other sections of the board, and they should never run near analog signal paths. Avoid crossover of digital and analog signals. Traces on layers in close proximity on the board should run at right angles to each other to reduce the effect of feedthrough through the board.

The power supply lines to the $A V_{C C}$ and $V_{\text {DRIVE }}$ pins should use as large a trace as possible to provide low impedance paths and reduce the effect of glitches on the power supply lines. Where possible, use supply planes and make good connections between the AD7607 supply pins and the power tracks on the board. Use a single via or multiple vias for each supply pin.
Good decoupling is also important in lowering the supply impedance presented to the AD7607 and in reducing the magnitude of the supply spikes. The decoupling capacitors should be placed close to (ideally, right up against) these pins and their corresponding ground pins. Place the decoupling capacitors for the REFIN/REFOUT pin and the REFCAPA and REFCAPB pins as close as possible to their respective AD7607 pins; and, where possible, they should be placed on the same side of the board as the AD7607 device.

Figure 52 shows the recommended decoupling on the top layer of the AD7607 board. Figure 53 shows bottom layer decoupling, which is used for the four $A V_{C C}$ pins and the $V_{\text {drive }}$ pin.


Figure 53. Bottom Layer Decoupling

To ensure good device-to-device performance matching in a system that contains multiple AD7607 devices, a symmetrical layout between the devices is important.
Figure 54 shows a layout with two AD7607 devices. The AV CC supply plane runs to the right of both devices. The $V_{\text {Drive supply }}$ track runs to the left of the two AD7607 devices. The reference chip is positioned between the two AD7607 devices, and the reference voltage track runs north to Pin 42 of U1 and south to Pin 42 of U2. A solid ground plane is used. These symmetrical layout principles can also be applied to a system that contains more than two AD7607 devices. The AD7607 devices can be placed in a north-south direction with the reference voltage located midway between the AD7607 devices and the reference track running in the north-south direction, similar to Figure 54.


Figure 54. Layout for Multiple AD7607 Devices—Top Layer and Supply Plane Layer

## OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-026-BCD
Figure 55. 64-Lead Low Profile Quad Flat Package [LQFP] (ST-64-2)
Dimensions shown in millimeters

## ORDERING GUIDE

| Model $^{1}$ | Temperature Range | Package Description | Package Option |
| :--- | :--- | :--- | :--- |
| AD7607BSTZ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | $64-$ Lead Low Profile Quad Flat Package [LQFP] | ST-64-2 |
| AD7607BSTZ-RL | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | 64-Lead Low Profile Quad Flat Package [LQFP] | ST-64-2 |
| EVAL-AD7607EDZ | $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ | Evaluation Board |  |
| CED1Z | Converter Evaluation Development |  |  |

[^3]
## NOTES


[^0]:    ${ }^{1}$ Temperature range for the B version is $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.
    ${ }^{2}$ See the Terminology section.
    ${ }^{3}$ This specification applies when reading during a conversion or after a conversion. If reading during a conversion in parallel mode with $V_{\text {DRNE }}=5 \mathrm{~V}$, SNR typically reduces by 1.5 dB and THD typically reduces by 3 dB .
    ${ }^{4}$ LSB means least significant bit. With $\pm 5 \mathrm{~V}$ input range, $1 \mathrm{LSB}=610.35 \mu \mathrm{~V}$. With $\pm 10 \mathrm{~V}$ input range, $1 \mathrm{LSB}=1.22 \mathrm{mV}$.
    ${ }^{5}$ This specification includes the full temperature range variation and contribution from the internal reference buffer but does not include the error contribution from the external reference.
    ${ }^{6}$ Bipolar zero code error is calculated with respect to the analog input voltage.
    ${ }^{7}$ Sample tested during initial release to ensure compliance.
    ${ }^{8}$ Operational power/current figure includes contribution when running in oversampling mode.

[^1]:    ${ }^{1} \mathrm{P}=$ power supply, $\mathrm{DI}=$ digital input, $\mathrm{DO}=$ digital output, $\mathrm{REF}=$ reference input/output, $\mathrm{AI}=$ analog input, $\mathrm{GND}=$ ground.

[^2]:    Figure 40. Simultaneous Sampling on Channel Sets While Using Independent CONVST A and CONVST B Signals_Parallel Interface Mode

[^3]:    ${ }^{1} Z=$ RoHS Compliant Part.

